

### **Features**

- 0805 1.1mm SMD LED
- High Brightness
- AllnGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

### **Applications**

- Consumer Electronics
- Wearables
- Automobile After Market
- Industrial Equipment

### **Description**

The IN-S85AT series is a popular low profile 0805 package with versatile design capabilities. It is a PCB type molding style LED which can be used in various applications.

### **Recommended Solder Pattern**

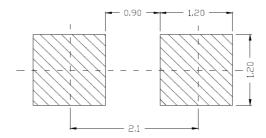
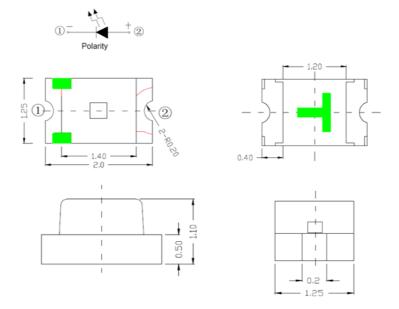


Figure 1. IN-S85AT Solder Pattern

# Package Dimensions in mm



### Notes.

- 1. All dimensions are in millimeters.
- 2. Tolerance is ± 0.1 mm unless otherwise noted

Figure 2. IN-S85AT Package Dimensions



# Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
IN-S85ATYG	Yellow Green						
IN-S85ATY	Yellow	75	25	70			
IN-S85ATA	Amber	75	25	70		-30°C~+85°C	-40°C~+90°C
IN-S85ATR	Red				5		
IN-S85AT5B	Blue						
IN-S85ATG	Green	75	25	100			
IN-S85AT5UW	White						

#### **Notes**

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



# **Electrical Characteristics** $T_A = 25\%$ (Note 1)

Product	Emission Color	I <sub>F</sub> (mA)	V <sub>F</sub> (V)	λ(nm)			Viewing Angle	I <sup>*</sup> <sub>V</sub> (mcd)
	Color	, ,	typ.	$\lambda_{D}$	$\lambda_{P}$	Δλ	2θ1/2	typ.
IN-S85ATYG	Yellow Green	20	2.2	572	576	15	120	45
IN-S85ATY	Yellow	20	2.2	592	594	15	120	115
IN-S85ATA	Amber	20	2.2	605	610	20	120	115
IN-S85ATR	Red	20	2.2	625	630	20	120	140
IN-S85AT5B	Blue	5	2.8	470	473	30	120	56
IN-S85ATG	Green	20	3.2	520	528	35	120	720
IN-S85AT5UW	White	5	2.8	X=0.27 Y=0.26	-	-	120	285

### **Notes**

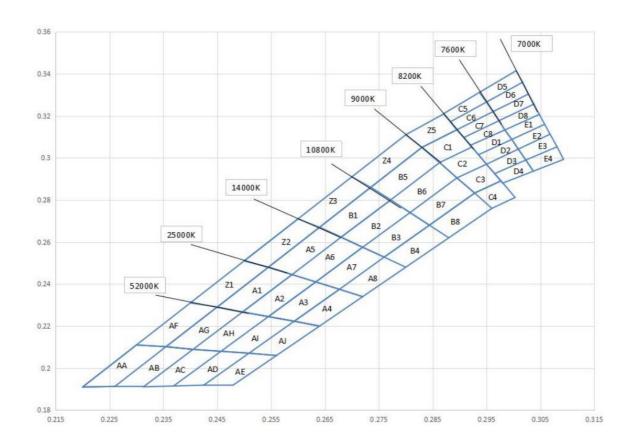
<sup>1.</sup> Performance guaranteed only under conditions listed in above tables.



# **Chromaticity Bin (for White only)**

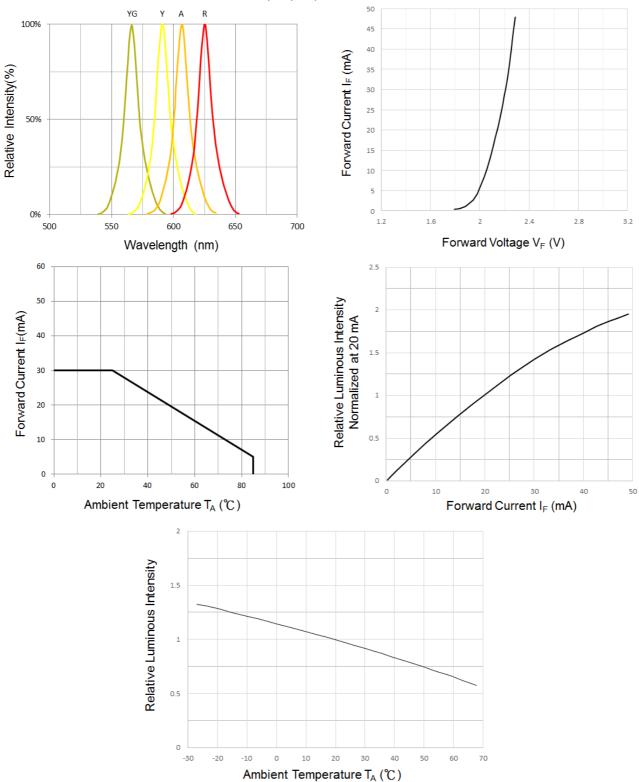
Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	
	0. 27	0. 291		0. 26	0. 271		0. 25	0. 251		0. 24	0. 231	
Z4	0. 28	0.311	Z3	0. 27	0. 291	Z2	0. 26	0. 271	Z1	0. 25	0. 251	
24	0. 283	0.305	25	0. 2735	0. 286	22	0. 264	0. 267	21	0. 2545	0. 248	
	0. 2735	0. 286		0. 264	0. 267		0. 2545	0. 248		0. 245	0. 2291	
	0. 2735	0. 2860		0. 2640	0. 2670		0. 2545	0. 2480		0. 2497	0. 2267	
B5	0. 2772	0. 2800	B1	0. 2680	0. 2623	A5	0. 2589	0. 2445	A1	0. 2450	0. 2290	
В	0. 2863	0. 2978	D1	0. 2772	0. 2800	, Ao	0. 2680	0. 2623	, AI	0. 2545	0. 2480	
	0. 2830	0.3050		0. 2735	0. 2860		0. 2640	0. 2670		0. 2589	0. 2445	
	0. 2772	0. 2800		0. 2720	0. 2575		0. 2589	0. 2445		0. 2497	0. 2267	
B6	0. 2808	0. 2740	B2	0. 2680	0. 2623	A6	0. 2633	0. 2410	A2	0. 2589	0. 2445	
ВО	0. 2895	0. 2905	D2	0. 2772	0. 2800	AU	0. 2720	0. 2575	AZ	0. 2633	0. 2410	
	0. 2863	0. 2978		0. 2808	0. 2740		0. 2680	0. 2623		0. 2545	0. 2245	
	0. 2808	0. 2740		0. 2720	0. 2575		0. 2677	0. 2375		0. 2593	0. 2223	
B7	0. 2844	0. 2680	B3	0. 2760	0. 2528	A7	0. 2633	0. 2410	A3	0. 2677	0. 2375	
D/	0. 2928	0. 2833	Бо	0. 2844	0. 2680	A.	0. 2720	0. 2575		0. 2633	0. 2410	
	0. 2895	0. 2905		0. 2808	0. 2740	1	0. 2760	0. 2528		0. 2545	0. 2245	
	0. 2844	0. 2680		0. 2760	0. 2528		0. 2720	0. 2340	A4		0. 2640	0. 2200
DO.	0. 2928	0. 2833	B4	0. 2844	0. 2680	1	0. 2677	0. 2375		0. 2593	0. 2223	
108	B8 0. 2960	0. 2760	D4	0. 2880	0. 2620	- A8	0. 2760	0. 2528		0. 2677	0. 2375	
	0. 2880	0. 2620		0. 2800	0. 2480		0. 2800	0. 2480		0. 2720	0. 2340	
	0. 28	0.311		0. 2830	0. 3050		0. 2863	0. 2978		0. 2895	0. 2905	
7.5	0. 2871	0. 321	C1	0. 2863	0. 2978	— C2	0. 2895	0. 2905		0. 2928	0. 2833	
Z5	0. 2895	0. 3134	C1	0. 2923	0. 3052		0. 2950	0. 2970	C3	0. 2977	0. 2891	
	0. 283	0.305	]	0. 2895	0. 3134	]	0. 2923	0. 3052		0. 2950	0. 2970	
	0. 2928	0. 2833		0. 2883	0.3172		0. 2883	0. 3172		0. 2895	0. 3134	
0.4	0. 2977	0. 2891	05	0. 2870	0. 3210		0. 2950	0. 3266	67	0. 2908	0. 3097	
C4	0. 3003	0. 2812	C5	0. 2937	0.3312	C6	0. 2962	0. 3220	C7	0. 2973	0.3177	
	0. 2960	0. 2760		0. 2950	0. 3266	1	0. 2895	0. 3134		0. 2962	0. 3220	
	0. 2908	0. 3097		0. 2920	0.3060		0. 2935	0. 3015		0. 2950	0. 2970	
	0. 2920	0.3060	D1	0. 2935	0. 3015	D0	0. 2950	0. 2970	D0	0. 2965	0. 2925	
C8	0. 2984	0. 3133	D1	0. 2997	0. 3088	D2	0. 3009	0. 3042	D3	0. 3023	0. 2990	
	0. 2973	0. 3177		0. 2984	0. 3133	1	0. 2997	0. 3088		0. 3009	0. 3042	
	0. 2965	0. 2925		0. 2937	0.3312		0. 2950	0. 3266		0. 2962	0. 3220	
D.4	0. 2980	0. 2880	D=	0. 2950	0. 3266	D.C.	0. 2962	0. 3220	D.7	0. 2973	0. 3177	
D4	0. 3037	0. 2937	D5	0. 3017	0. 3360	D6	0. 3028	0. 3304	D7	0. 3038	0. 3256	
	0. 3023	0. 2990		0. 3005	0. 3415	1	0. 3017	0. 3360		0. 3028	0. 3304	
	0. 2973	0. 3177		0. 2973	0.3177		0. 2973	0. 3177		0. 2973	0. 3177	
	0. 2984	0. 3133		0. 2984	0. 3133	-	0. 2984	0. 3133		0. 2984	0. 3133	
D8	0. 3048	0. 3207	E1	0. 3048	0. 3207	E2	0. 3048	0. 3207	E3	0. 3048	0. 3207	
	0. 3038	0. 3256	1	0. 3038	0.3256	1	0. 3038	0. 3256		0. 3038	0. 3256	
	0. 2973	0. 3177		0. 2425	0. 1919		0. 2300	0. 2110		0. 2355	0. 2102	
	0. 2984	0. 3133		0. 2480	0. 1920	1	0. 2355	0. 2102	†	0. 2405	0. 2089	
E4	0. 3048	0. 3207	AE	0. 2560	0. 2060	AF	0. 2450	0. 2291	AG	0. 2497	0. 2267	
	0. 3038	0. 3256	1	0. 2509	0. 2071	1	0. 2400	0. 2310		0. 2450	0. 2291	





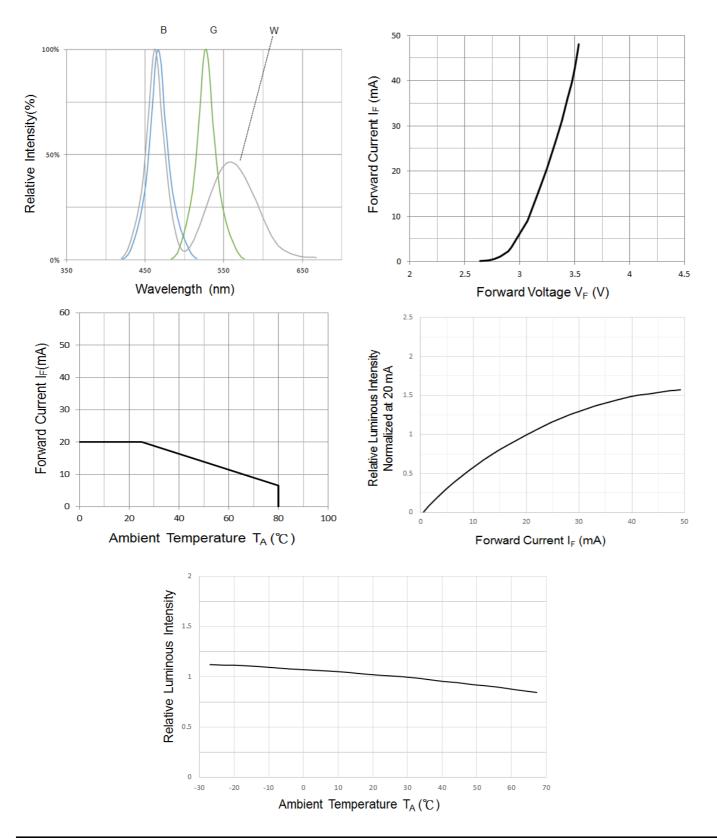


# Typical Characteristic Curves - YG, Y, A, R



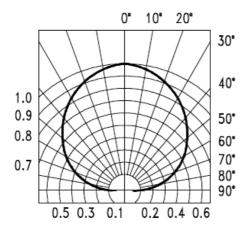


# Typical Characteristic Curves - B, G, W





# **Typical Characteristic Curves – Radiation Pattern**

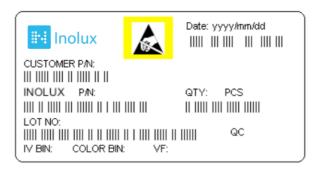


# **Ordering Information**

Product	Emission Color	Technology	Test Current I <sub>F</sub> (mA)	Luminous Intensity Iv (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
IN-S85ATYG	Yellow Green	AllnGaP	20	45	2.2	IN-S85ATYG
IN-S85ATY	Yellow	AllnGaP	20	115	2.2	IN-S85ATY
IN-S85ATA	Amber	AllnGaP	20	115	2.2	IN-S85ATA
IN-S85ATR	Red	AllnGaP	20	140	2.2	IN-S85ATR
IN-S85AT5B	Blue	InGaN	5	56	2.8	IN-S85AT5B
IN-S85ATG	Green	InGaN	20	720	3.2	IN-S85ATG
IN-S85AT5UW	White	InGaN	5	285	2.8	IN-S85AT5UW



### **Label Specifications**



### Inolux P/N:

1	N	-	S	8	5	Α	T				-	-	-	
			Material	Pacl	kage	Variation	Orientation	Current	Lens	Color				nized o-off
	olux MD		S = PCB Type	85A =	- 2.0 x 1	25 x 1.1mm	T = Top Mount	(Blank) = 20mA 5=5mA	(Blank) = Clear U = Diffused	R=622nm A=609nm Y=593nm YG=574nm G=530nm B=468nm W=White			-	

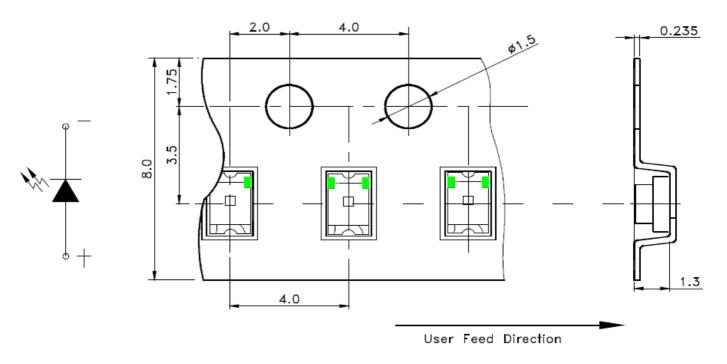
### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2019 \	Month	Date	Serial	
Tracker		rear (2017)	, 2016,)		WOTEH	Date	Serial

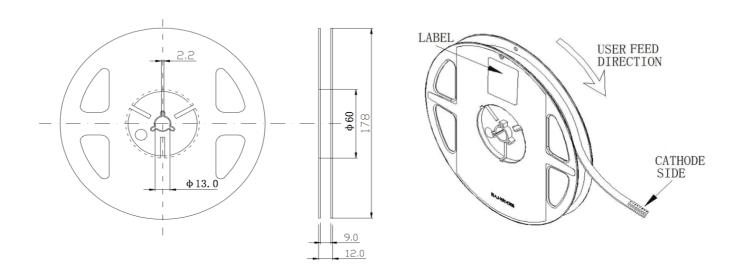


# Packaging Information: 3000pcs Per Reel

# **Tape Dimension**

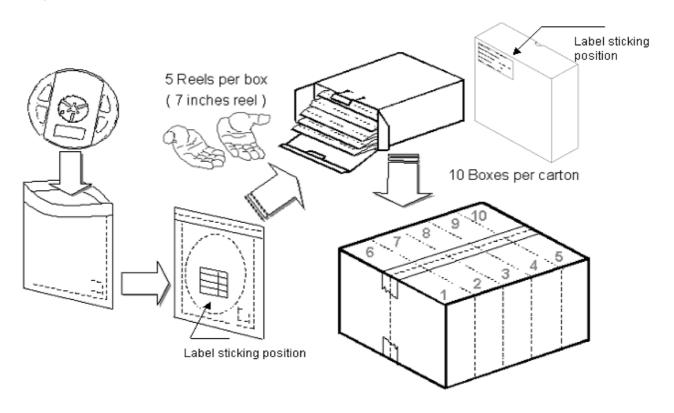


### **Reel Dimension**





### **Packing Dimension**



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	3000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Othora			

#### Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

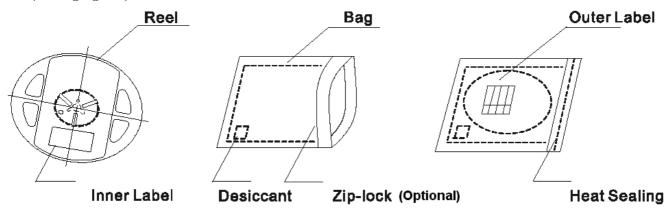


### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

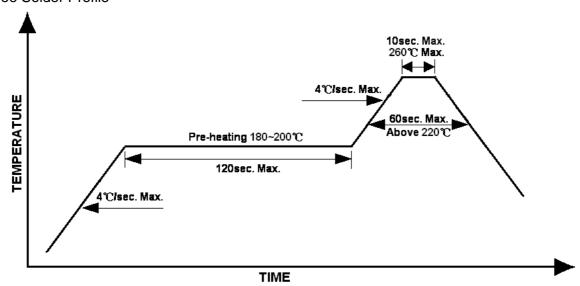
The packaging sequence is as follows:



# **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

#### Lead-free Solder Profile





### **Precautions**

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter</li>
- Curing: 100 °C max, <3min

### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



# IN-S85AT series Top View SMD LED 0805 PCB Type

Reliability

liability			
Item	Frequency/ lots/ samples/	Standards	Conditions
Item	failures	Reference	
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according		2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
Ligh tomporature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
High temperature			IF=20mA
bias			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 μ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
<u>,</u>		IEC 68-2-14, Nb	15min
Temperature		,	Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



# IN-S85AT series Top View SMD LED 0805 PCB Type

**Revision History** 

Changes since last revision	Page	Version No.	Revision Date
Initial Release		V1.0	02-07-2017
Updated	10,11	V1.1	02-13-2019
Updated	3,4,5,8	V1.2	01-23-2022

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.